

### United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
09/808,484	03/14/2001	Kelly T. Hurley	MIO 0064 PA	3606	
75	90 03/31/2003				
Killworth, Gottman, Hagan & Schaeff, L.L.P. One Dayton Centre One South Main Street Suite 500			EXAMINER		
			QUINTO, KEVIN V		
			<u></u>	***************************************	
Dayton, OH 45	5402-2023		ART UNIT	PAPER NUMBER	
			2826		
			DATE MAILED: 03/31/2003		
_					

Please find below and/or attached an Office communication concerning this application or proceeding.

Application No.  O8fic Action Summary    Saminer				Su-				
Peri of 1 rReply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE of this communication appears on the cov r sheet with the correspondence address Peri of 1 rReply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CPR 1.138(e). In no awant, however, may an epyle but inney filled after St (X (MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (20) days, a reply which the statictory minimum of thirty (20) days, a reply which the statictory minimum of thirty (20) stays, a reply which the statictory minimum of thirty (20) stays, a reply which the state of the scenario date of the scenario	,	Application No.	Applicant(s)					
Revin Quinto   2826	, Office Action Commons	09/808,484	HURLEY ET AL.					
Peri of reply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  Estensions of them may be variable under the provisions of 3 CPR 1.138(a). In no event, bowever, may a reply be limity filed after SIX (8) MONTH'S from the mailing date of this communication.  If the period or reply spelline allow is lise team him (20) days, a reply within the statutory initimum of thith (30) days, and in the period of the provision of the reply see allow is lise to make (20) and in the statutory initimum of thith (30) days, and is searned palent from adjustment. See 37 CPR 1.79(b).  Failure to reply within the set or ordered period for reply will, by shatute, cause the spellication to become ABANDONED (38 U.S.C. § 133).  Any reply received by the Office liber than three months after the mailing date of this communication, even if timely filed, may reduce any examed palent form adjustment. See 37 CPR 1.79(b).  Status  1) ■ Responsive to communication(s) filed on @6 January 2003.  2a) ■ This action is FINAL. 2b) ■ This action is non-final.  3) ■ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims  4) ■ Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s) ■ is/are withdrawn from consideration.  5) □ Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are rejected.  7) □ Claim(s) ■ is/are objected to.  Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are rejected.  7) □ Claim(s) ■ is/are objected to by the Examiner.  Application Papers  9) □ The specification is objected to by the Examiner.  Application Papers  9) □ The proposed drawing correction filed on ■ is/are: a) □ accepted or b) □ objected to by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) □ The cath or declaration is object	Offic Action Summary	Examiner	Art Unit					
Peri of f r Reply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE ③ MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  Extensions of time may be available under the provisions of 3 °CFR 1.136(a). In no event, however, may a raply be timely filed allest SX (6) MCNTH3 from the maining date of this communication.  If Mo period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) days will be considered timely.  If Mo period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) days will be considered timely.  If Mo period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MCNTH3 from the mining date of this communication.  Finiture to reply within the set or cardended period for reply will, by teating cause the specification to become ARANDONED (38 U.S.C. § 133).  Any reply received by the Office later than three menths after the mailing date of this communication, even if timely filed, may reduce any Stature and protein term displanants. Set 5 O'RE 1.7040.  Statures  This action is FINAL.  2b) This action is non-final.  3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims  4) Claim(s) 12.19-22.24.25.33.44.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s) is/are allowed.  5) Claim(s) is/are allowed.  6) Claim(s) is/are allowed.  6) Claim(s) is/are allowed.  6) Claim(s) is/are allowed.  7) Claim(s) is/are objected to.  8) Claim(s) is/are objected to by the Examiner.  10) The drawing(s) filed on is/are allowed.  10) The drawing(s) filed on is/are allowed.  11) The proposed drawing correction filed on is/are allowed.  12) Chaim(s) is/are allowed.  13) accepted or by the Examiner.  14) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).	st.							
THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be suitable under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely flied after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thinky (30) days, a perly within the saturity minimum of timing (30) days.  - Failure to reply within the sat or extended period for reply will by statute, causes the application to become ABANDONED (55 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any carried patent term adjustment. See 37 CFR 1.704(b).  Status  1)  Responsive to communication(s) filed on 06 January 2003.  2a)  This action is FINAL. 2b)  This action is non-final.  3)  Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Exparte Quayle, 1935 c.D. 11, 453 O.G. 213.  Disposition of Claims  4)  Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s)  is/are allowed.  6)  Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are rejected.  7)  Claim(s)  is/are objected to.  8)  Claim(s)  are subject to restriction and/or election requirement.  Application Papers  9)  The specification is objected to by the Examiner.  10)  The drawing(s) filed on  is/are: a)  accepted or b)  objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11)  The proposed drawing correction filed on  is/are: a)  approved b)  disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Cffice action.  12)  The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119(a)-(d) or (f).  a)  Alt   Derified copies of the priority documents have been received in Application No.  in 11								
2a) This action is FINAL.  2b) This action is non-final.  3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims  4) Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s) is/are withdrawn from consideration.  5) Claim(s) is/are allowed.  6) Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74, and 76 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. § 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  *See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).							
3)	1) Responsive to communication(s) filed on <u>06 J</u>	lanuary 2003 .						
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims  4) Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s) is/are withdrawn from consideration.  5) Claim(s) is/are allowed.  6) Claim(s) 12.19-22.24.25.33.34, 36-38.40.73.74. and 76 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	2a)⊠ This action is <b>FINAL</b> . 2b)⊡ Thi	is action is non-final.						
4) Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74 and 76 is/are pending in the application.  4a) Of the above claim(s) is/are withdrawn from consideration.  5) Claim(s) is/are allowed.  6) Claim(s) 12.19-22.24.25.33.34.36-38.40.73.74.and 76 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.							
4a) Of the above claim(s) is/are withdrawn from consideration.  5) □ Claim(s) is/are allowed.  6) ☒ Claim(s) is/are allowed.  7) □ Claim(s) is/are objected to.  8) □ Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) □ The specification is objected to by the Examiner.  10) □ The drawing(s) filed on is/are: a) □ accepted or b) □ objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) □ The proposed drawing correction filed on is: a) □ approved b) □ disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) □ The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) □ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) □ All b) □ Some * c) □ None of:  1. □ Certified copies of the priority documents have been received.  2. □ Certified copies of the priority documents have been received in Application No  3. □ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) □ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) □ The translation of the foreign language provisional application has been received.								
5) □ Claim(s) is/are allowed. 6) □ Claim(s) is/are objected to. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) □ The specification is objected to by the Examiner.  10) □ The drawing(s) filed on is/are: a) □ accepted or b) □ objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) □ The proposed drawing correction filed on is: a) □ approved b) □ disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) □ The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) □ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) □ All b) □ Some * c) □ None of:  1. □ Certified copies of the priority documents have been received.  2. □ Certified copies of the priority documents have been received in Application No  3. □ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) □ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) □ The translation of the foreign language provisional application has been received.								
6)								
7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved by disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.								
8) Claim(s) are subject to restriction and/or election requirement.  Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.								
Application Papers  9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. § 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.								
10)  The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner. If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	9)☐ The specification is objected to by the Examiner.							
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.  If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.							
If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
12) The oath or declaration is objected to by the Examiner.  Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.							
Pri rity under 35 U.S.C. §§ 119 and 120  13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	If approved, corrected drawings are required in reply to this Office action.							
<ul> <li>13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) ☐ All b) ☐ Some * c) ☐ None of:</li> <li>1. ☐ Certified copies of the priority documents have been received.</li> <li>2. ☐ Certified copies of the priority documents have been received in Application No</li> <li>3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> <li>14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).</li> <li>a) ☐ The translation of the foreign language provisional application has been received.</li> </ul>	12) The oath or declaration is objected to by the Examiner.							
<ul> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> <li>14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).</li> <li>a) The translation of the foreign language provisional application has been received.</li> </ul>	Pri rity under 35 U.S.C. §§ 119 and 120							
<ul> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> <li>14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).</li> <li>a) The translation of the foreign language provisional application has been received.</li> </ul>	13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
<ul> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> <li>14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).</li> <li>a) The translation of the foreign language provisional application has been received.</li> </ul>	a) ☐ All b) ☐ Some * c) ☐ None of:							
<ul> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> <li>14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).</li> <li>a) The translation of the foreign language provisional application has been received.</li> </ul>	1. Certified copies of the priority documents have been received.							
application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.  14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  a) The translation of the foreign language provisional application has been received.	2. Certified copies of the priority documents have been received in Application No							
a) The translation of the foreign language provisional application has been received.	application from the International Bureau (PCT Rule 17.2(a)).							
_ '	14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).							
	_ '							
Attachment(s)								
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)  4) Interview Summary (PTO-413) Paper No(s)  5) Notice of Informal Patent Application (PTO-152)  6) Other:	2) DNotice of Draftsperson's Patent Drawing Review (PTO-948)	5) Notice of Informal						

#### **DETAILED ACTION**

# Response to Arguments

1. Applicant's arguments with respect to claims 12, 19-22, 24, 25, 33, 34, 36-38, 40, 73, 74, and 76 have been considered but are moot in view of the new ground(s) of rejection.

# Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).
- 4. In reference to claim 12, figures 6a-6f of Hong (USPN 5,770,501) disclose a device which meets the claim. Figures 6a-6f illustrate a substrate (50) with at least one semiconductor layer (50). There is at least one trench formed in the substrate (50). There is a field oxide (542) inside the at least one trench and it extends above an upper surface of the substrate (50). A tunnel oxide layer (512) is formed over at least a portion of the substrate (50). There is at least one floating gate layer (514a) formed over the tunnel oxide layer (512). There is at least one polysilicon ear (552) formed on

the at least one floating gate layer (514a) and is adjacent to the field oxide (542). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu et al. (USPN 6,462,373 B2, hereinafter referred to as the "Shimizu" reference) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

5. Claims 19 and 20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).

6. With regard to claim 19, figures 6a-6f of Hong disclose a device which meets the claim. Figures 6a-6f illustrate a substrate (50) with at least one semiconductor layer (50). There is a plurality of trenches formed in the substrate (50). A field oxide (542) is inside each of the trenches. A tunnel oxide layer (512) is formed over the substrate (50). A floating gate layer (514a) is formed over the tunnel oxide layer (512). A pair of polysilicon ears (552) are formed adjacent to the field oxide regions (542) on the floating gate layer (514a). The polysilicon ears (552) are projecting substantially perpendicular to the upper surface of the floating gate layer (514a). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu et al. (USPN 6,462,373 B2, hereinafter referred to as the "Shimizu" reference) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement Application/Control Number: 09/808,484

Art Unit: 2826

the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

- 7. In reference to claim 20, Hong meets the limitation of the claim. Figures 6a-6f shows that the floating gate layer (514a) comprises a plurality of floating gates and a corresponding pair of polysilicon ears for each of the plurality of floating gates.
- 8. Claims 21 and 22 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).
- 9. In reference to claim 21, figures 6a-6f of Hong disclose a device which meets the claim. Figures 6a-6f illustrate a substrate (50) with at least one semiconductor layer (50). There is a plurality of trenches formed in the substrate (50). A field oxide (542) is inside each of the trenches. A tunnel oxide layer (512) is formed over the substrate (50). A floating gate layer (514a) is formed over the tunnel oxide layer (512). A pair of polysilicon ears (552) are formed adjacent to a portion of the floating gate (514a). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-

Page 6

Art Unit: 2826

65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

- 10. In reference to claim 22, Hong meets the limitation of the claim. Figures 6a-6f shows that the floating gate layer (514a) comprises a plurality of floating gates and a corresponding pair of polysilicon ears for each of the plurality of floating gates.
- 11. Claim 24 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).
- 12. In reference to claim 24, figures 6a-6f and 7 of Hong (USPN 5,770,501) disclose a device which meets the claim. Figures 6a-6f and 7 illustrate a substrate (50) with at least one semiconductor layer (50). There is at least one trench formed in the substrate (50). There is a source and a drain (572, both of them) formed in the substrate (50). There is a field oxide (542) inside a trench and it extends above an upper surface of the substrate (50). A tunnel oxide layer (512) is formed over at least a portion of the substrate (50). There is at least one floating gate layer (514a) formed over the tunnel

oxide layer (512). There is at least one polysilicon ear (552) formed on the at least one floating gate layer (514a) and is adjacent to the field oxide (542). There is a dielectric layer (562) formed over the substrate (50) and the floating gate layer (514a). There is a control gate layer (564(a)) formed over the dielectric layer (562). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

13. Claim 25 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).

14. In reference to claim 25, figures 6a-6f and 7 of Hong (USPN 5,770,501) disclose a device which meets the claim. Figures 6a-6f and 7 illustrate a substrate (50) with at least one semiconductor layer (50). There is at least one trench formed in the substrate (50). There is a source and a drain (572, both of them) formed in the substrate (50). A tunnel oxide layer (512) is formed over at least a portion of the substrate (50). There is at least one floating gate layer (514a) formed over the tunnel oxide layer (512). There is a field oxide (542) inside a trench. There is at least one polysilicon ear (552) formed on the at least one floating gate layer (514a). There is a dielectric layer (562) formed over the substrate (50) and the floating gate layer (514a). There is a control gate layer (564(a)) formed over the dielectric layer (562). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory Application/Control Number: 09/808,484

Art Unit: 2826

cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. You et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

- 15. Claims 33, 34, and 36-38 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).
- 16. With regard to claims 33 and 34, figures 6a-6f and 7 of Hong (USPN 5,770,501) disclose a device which meets these claims. Figures 6a-6f and 7 illustrate a device with a source and a drain (572, both of them) formed in a substrate (50). There is a floating gate (514a) formed over the substrate (50). There is a field oxide (542) formed in a trench in the substrate (50). There is a polysilicon ear (552) formed over the substrate (50). There is a dielectric layer (562) formed over the substrate (50) and the floating gate layer (514a). There is a control gate layer (564(a)) formed over the dielectric layer (562). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4,

lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28-32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

- 17. In reference to claim 36, figures 6a-6f of Hong show that the ear (552) extends beyond the bounds of the floating gate (514a).
- 18. In reference to claim 37, figures 6a-6f of Hong show that the near vertical sides of the ear (552) do not contact the floating gate (514a).
- 19. With regard to claim 38, figures 6a-6f of Hong show that the near vertical edge of the ear (552) is adjacent to the field oxide (542) while the bottom edge of the ear (552) is adjacent to the floating gate (514a).
- 20. Claim 40 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).

In reference to claim 40, figures 5, 6a-6f and 7 of Hong (USPN 5,770,501) 21. disclose a device which meets the claim. Figures 5, 6a-6f and 7 illustrate a substrate (50) with a source and a drain (572, both of them). It is understood that the source and the drain are formed in common regions with adjacent memory cells. There is a floating gate layer (514a) with a pair of polysilicon ears (552) in a trench. Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. There is a control gate (564(a)) associated with each row. Figure 5 shows that the control gate layer (564(a)) is formed as a common word line which is associated with each row. It is understood that the control gate is formed integral with the word line since Hong interchangeably uses the terms "control gate" and "word lines" (column 3, lines 48-51). Hong does not disclose the use of a conductive bit line which is connected to the drain of each memory cell in a row in conjunction with a common source line, otherwise known as the NOR configuration. However it is well known in the art to implement a flash memory in this manner. Yoo et al. (USPN 5,747,848) discloses that NOR-type devices have a higher speed than NAND-type devices (column 1, lines 28Application/Control Number: 09/808,484 Page 12

Art Unit: 2826

32). It would therefore be obvious to implement the device of Hong with a common source line and a conductive bit line that is connected to the drain of each memory cell in a row in order to attain the benefit of a high speed memory.

- 22. Claims 73, 74, and 76 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hong (USPN 5,770,501) in view of Shimizu et al. (USPN 6,462,373 B2) and further in view of Yoo et al. (USPN 5,747,848).
- 23. In reference to claims 73 and 74, figures 6a-6f of Hong (USPN 5,770,501) disclose a device which meets the claim. Figures 6a-6f illustrate a substrate (50) with a field oxide region (542) in a trench. There is a tunnel oxide layer (512) formed on the substrate (50) adjacent the field oxide region (542). Hong does not disclose the use of a sloped isolation trench. However the use of a sloped isolation trench in a nonvolatile semiconductor device is well known in the art. Shimizu (USPN 6,462,373 B2) discloses that using a sloped isolation trench prevents the formation of voids in the isolation material within the trench (column 10, lines 51-60). Such voids can lead to a loss in planarity for isolation material in the trench (column 4, lines 28-31). Shimizu also discloses that using a sloped isolation trench allows a larger channel length while suppressing a decrease in threshold voltage (column 9, lines 53-65). It would therefore be obvious to use sloped isolation trenches in the device of Hong. There is at least one floating gate layer (514a) formed over the tunnel oxide layer (512). There is at least one polysilicon structure (552) formed adjacent to the at least one floating gate layer (514a). This polysilicon structure or ear increases the capacitive coupling of the memory cell.

24. With regard to claim 76, figures 6a-6f of Hong shows that the polysilicon structure or ear is formed adjacent to the field oxide region (542).

#### Conclusion

25. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin Quinto whose telephone number is (703) 306-5688. The examiner can normally be reached on M-F 8AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on (703) 308-6601. The fax phone numbers

Application/Control Number: 09/808,484 Page 14

Art Unit: 2826

for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

KVQ March 24, 2003

SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800

LECHNOFCE\* OFFICE AND A COMMENTAL SECTION OF THE PROPERTY OF T